

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
HONG HU	06/24/2015
QINGMING SHU	06/24/2015
SAI ZHANG	06/24/2015
JIANJUN ZHANG	06/24/2015
JIANG LIU	06/24/2015
RONGHUA PAN	06/24/2015
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	GIGADEVICE SEMICONDUCTOR (BEIJING) INC.
<b>Street Address:</b>	SUITE 01-15, A12, TIANGONG BUILDING XUEYUAN ROAD NO. 30, HAIDIAN DISTRICT
<b>City:</b>	BEIJING
<b>State/Country:</b>	CHINA
<b>Postal Code:</b>	100083
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	14760207
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	702-724-2628
<b>Email:</b>	in@bayramoglu-legal.com
<b>Correspondent Name:</b>	GOKALP BAYRAMOGLU
<b>Address Line 1:</b>	8275 SOUTH EASTERN AVENUE SUITE 200-611
<b>Address Line 4:</b>	LAS VEGAS, NEVADA 89123
<b>ATTORNEY DOCKET NUMBER:</b>	GBRZH016
<b>NAME OF SUBMITTER:</b>	GOKALP BAYRAMOGLU
<b>SIGNATURE:</b>	/Gokalp Bayramoglu/
<b>DATE SIGNED:</b>	07/10/2015

**Total Attachments: 2**

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ASSIGNMENT

(1-8) <i>Insert Name(s) of Inventor(s)</i>	(1) Hong HU	(2) Qingming SHU
	(3) Sai ZHANG	(4) Jianjun ZHANG
	(5) Jiang LIU	(6) Ronghua PAN

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For good and valuable consideration receipt of which is hereby acknowledged, the undersigned agree(s) to assign, and hereby do(es) assign, transfer and set over to:

(9) <i>Insert name of Assignee</i>	(9) GIGADEVICE SEMICONDUCTOR (BEIJING) INC.
(10) <i>Insert state of incorporation of Assignee</i>	(10) China
(11) <i>Insert address of Assignee</i>	(11) Suite 01-15, A12, Tiangong Building Xueyuan Road No. 30, Haidian District Beijing 100083 (hereinafter designated as the Assignee) the entire worldwide right, title, interest, and patent applications and patents for every country, including divisions, reissues, continuations and all other extensions, rights and priorities in the invention known as and subject matter contained in
(12) <i>Insert Identification of Invention, such as Title, Case Number or Foreign Application Number</i>	(12) <u>ENHANCED FLASH CHIP AND METHOD FOR PACKAGING CHIP</u>
(13) <i>Insert Date of Filing of Application</i>	(13) <u>Application is attached hereto.</u>

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1) The undersigned agree(s) to execute all papers necessary in connection with the application and any continuing or division applications thereof and also to execute separate assignments in connection with such applications as the Assignee may deem necessary or expedient.

2) The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this application or continuation or division thereof and to cooperate with the Assignee in every way possible in obtaining evidence and going forward with such interference.

3) The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property or similar agreements.

4) The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the Assignee.

5) The undersigned hereby authorize(s) and request(s) the Commissioner for Patents and the duly constituted authorities of foreign countries to issue any and all Letters Patents resulting from said application or any division or divisions or continuing or reissue applications thereof to the said Assignee, its successors and assigns, as Assignee of the entire right, title and interest, and hereby covenants that he has (they have) full right to convey the entire interest herein assigned, and that he has (they have) not executed and will not execute, any agreement in conflict herewith.

6) *The undersigned hereby grant(s)*

Gokalp Bayramoglu, Reg.No. 66305

*the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.*

Date 2015.6.24

Hong HU  
Hong HU

Date 2015.6.24

Qingming SHU  
Qingming SHU

Date 2015.6.24

Sai Zhang  
Sai ZHANG

Date 2015.6.24

Jianjun ZHANG  
Jianjun ZHANG

Date 2015.6.24

Jiang LIU  
Jiang LIU

Date 2015.6.24

Ronghua PAN  
Ronghua PAN